



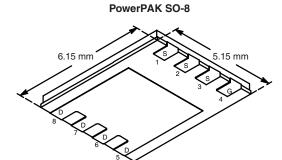
P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}$ (Ω)	$I_D\left(\Omega\right)$			
- 60	0.064 at V _{GS} = - 10 V	- 5	26		
	0.080 at $V_{GS} = -4.5 \text{ V}$	- 4.5	20		

FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFET
- New Low Thermal Resistance PowerPAK[®] Package with Low 1.07 mm Profile

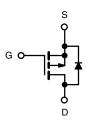




Bottom View

Ordering Information: Si7465DP-T1-E3 (Lead (Pb)-free)

Si7465DP-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_A = 25 ^{\circ}C$, unles	ss otherwise n	oted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	- 60		V
Gate-Source Voltage		V_{GS}	± 20		V
Continuous Drain Current /T 150°C\a	T _A = 25 °C	I _D	- 5	- 3.2	
Continuous Drain Current (T _J = 150°C) ^a	T _A = 70 °C		- 4	- 2.6	
Pulsed Drain Current		I _{DM}	- 25		Α
Continuous Source Current (Diode Conduction) ^a		I _S	- 2.9	- 1.2	
Avalanche Current	L = 0.1 mH	I _{AS}	22		
Single Pulse Avalanche Energy	L = 0.1 IIII1	E _{AS}	24.2		mJ
Manianum Danier Disaination 8	T _A = 25 °C	P _D	3.5	1.5	W
Maximum Power Dissipation ^a	T _A = 70 °C		2.2	0.94	VV
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C
Soldering Recommendations (Peak Temperature) ^{b,c}			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Marrian una luncation de Analaianda	t ≤ 10 s	R _{thJA}	27	36	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		60	85		
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	3.3	4.3		

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Solder Profile (www.vishay.com/ppg?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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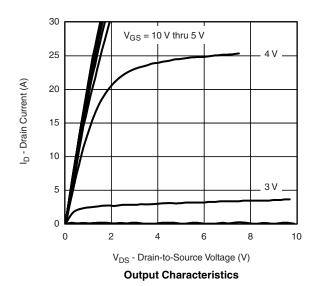
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static			•	•		
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.0		- 3.0	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zana Cata Valtana Duain Courset	I _{DSS}	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 \text{ °C}$			- 1	μΑ
Zero Gate Voltage Drain Current					- 10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 5 V, V_{GS} = - 10 V	- 25			Α
	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 5 A	0.051 0.0		0.064	Ω
Drain-Source On-State Resistance ^a		V _{GS} = - 4.5 V, I _D = - 4.5 A		0.064	0.080	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 5 A		16		S
Diode Forward Voltage ^a	V_{SD}	I _S = - 2.9 A, V _{GS} = 0 V		- 0.8	- 1.2	V
Dynamic ^b			•	•		
Total Gate Charge	Q_g			26	40	nC
Gate-Source Charge	Q_{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -5 \text{ A}$		4.5		
Gate-Drain Charge	Q_{gd}			7.0		
Gate Resistance	R_{g}			7.0		Ω
Turn-On Delay Time	t _{d(on)}			8	15	
Rise Time	t _r	V_{DD} = - 30 V, R_L = 30 Ω		9	15	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ - 1.0 A, $V_{GEN}=-10$ V, $R_g=6~\Omega$		65	100	ns
Fall Time	t _f			30	45	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 5 A, dl/dt = 100 A/μs		41	70	

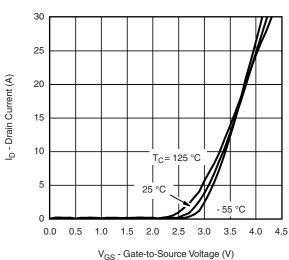
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



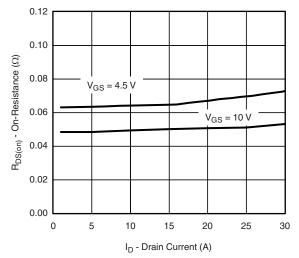


VGS - Gale-10-Double Vollage (V

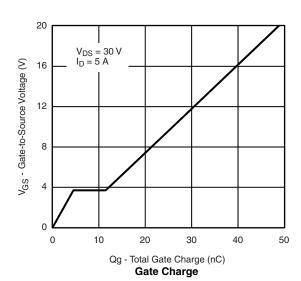
Transfer Characteristics

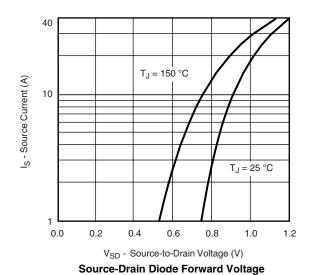


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Drain Current





1800 1500 C - Capacitance (pF) Ciss 1200 900 600 C_{rss}

300

0

0

10

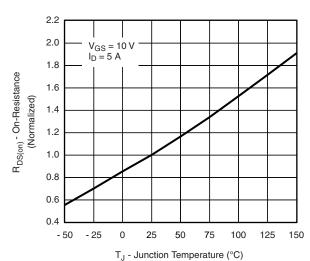
20

30 V_{DS} - Drain-to-Source Voltage (V) Capacitance

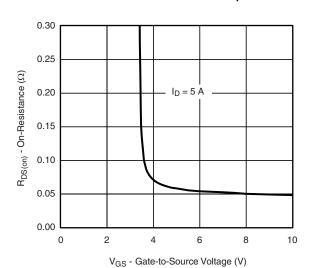
40

50

60



On-Resistance vs. Junction Temperature



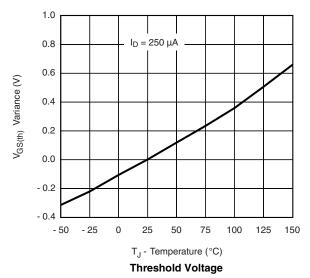
On-Resistance vs. Gate-to-Source Voltage

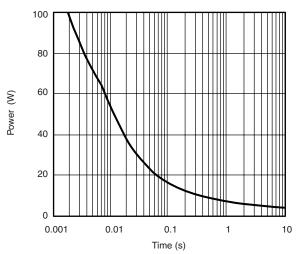
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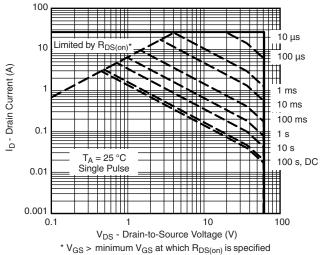
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

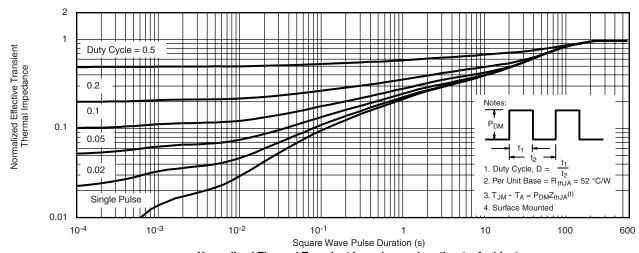




Single Pulse Power, Junction-to-Ambient



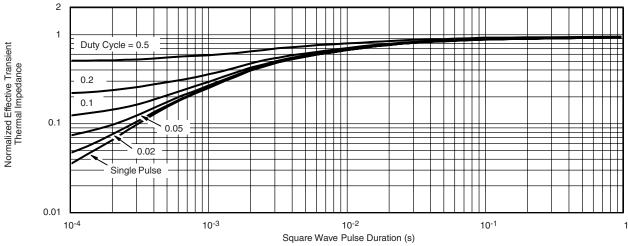




Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

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